

WP2090KA

Enhancement Mode N-Channel Power MOSFET

TO-252/NMOS/20V/±12V/0.95V/90A/3.0mΩ

Rev0.6







20V, 3.0mΩ, 90A, Single N-Channel

1.Features

- ◆ 20V MOSFET technology
- Low on-state resistance
- Fast switching
- ♦ Vgs±12V

2.Applications

- Power Switching Application
- Load Switching



V _{DS}	R _{DS(on)} Typ.	I _D Max.	
	3.0mΩ @ 7.4V		
20V	3.4mΩ @ 4.5V	90A	
	5.5mΩ @ 2.5V		



Schematic Diagram

3. Package Marking and Ordering Information

Part no.	Marking	Package	PCS/Reel	PCS/CTN.
WP2090KA	WP2090KA	TO-252	2,500	25,000

4.Absolute Max Ratings at Ta=25°C (Note1)

Parameter	Symbol	Maximum	Units
Drain to Source Voltage	V _{DSS}	20	V
Gate to Source Voltage	Vgss	±12	V
Drain Current (DC)	lo	90	А
Drain Current (Pulse), PW≤300µs	I _{DP}	243	А
Total Dissipation	PD	83	W
Avalanche Energy, Single Pulsed	Eas	240	mJ
Junction Temperature	Tj	150	°C
Storage Temperature	T _{stg}	-55 to +150	°C

Note 1: Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.



5.Thermal Resistance Ratings

Parameter	Symbol	Value	Unit
Junction to case	Rejc	1.8	°C/W

Note 2: When mounted on 1 inch square copper board t \leq 10sec The value in any given application depends on the user's specific board design.

6.Electrical Characteristics at Ta=25°C (Note 3)

Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Units
Drain to Source Breakdown Voltage	V _{(BR)DSS}	I _D = 250µA, V _{GS} = 0V	20	21.5		V
Zero-Gate Voltage Drain Current	IDSS	V _{DS} = 20V, V _{GS} = 0V			100	nA
Gate to Source Leakage Current	Igss	V_{GS} = ±12V, V_{DS} = 0V			±100	nA
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _{DS} =250µA	0.5	0.95	1.2	V
	R _{DS(on)}	I _D = 30A, V _{GS} = 7.4V	-	3.0	3.7	mΩ
Static Drain to Source On-State Resistance		I _D = 20A, V _{GS} = 4.5V	-	3.4	4	mΩ
กรารเล่าเปล		I _D = 10A, V _{GS} = 2.5V	-	5.5	9	mΩ
Forward Transconductance	GFS	I _D = 20A, V _{DS} = 5V	20			S
Input Capacitance	Ciss	V _{GS} =0V,		4098		pF
Output Capacitance	Coss	V _{DS} =10V,		1519		pF
Reverse Transfer Capacitance	Crss	Frequency=1.0MHz		1238		pF
Turn-ON Delay Time	t _{d(on)}			6		ns
Rise Time	tr	$V_{DD} = 10V, I_D = 20A,$		4		ns
Turn-OFF Delay Time	t _{d(off)}	$V_{GS} = 10V,$ $R_{GEN} = 2.7\Omega$		31		ns
Fall Time	tf			5		ns
	Qg	V _{DS} = 10V,		15		nC
Total Gate Charge	Q _{gs}	$V_{GS} = 4.5V,$		3		nC
	Q _{gd}	I _D = 20A		4		nC
Diode Forward Voltage	V _{FSD}	I _S = 20A, V _{GS} = 0	0.5	0.8	1.2	V

Note 3: Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.



7. Typical electrical and thermal characteristics





WP2090KA



Square Wave Pluse Duration(sec)

Normalized Maximum Transient Thermal Impedance



8.Package Dimensions







	WILL INFTED			
SYMBOL	MILLIMETER			
	MIN	Typ.	MAX	
А	2.200	2.300	2.400	
A1	0.000		0.127	
b	0.640	0.690	0.740	
c(电镀后)	0.460	0. 520	0.580	
D	6.500	6.600	6.700	
D1	5.334 REF			
D2	4.826 REF			
D3	3.166 REF			
Е	6.000	6.100	6.200	
е	2.286 TYP			
h	0.000	0.100	0.200	
L	9.900	10.100	10.300	
L1	2.888 REF			
L2	1.400	1.550	1.700	
L3	1.600 REF			
L4	0.600	0.800	1.000	
ф	1.100	1.200	1.300	
θ	0°		8°	
θ1	9° TYP			
θ2	9° TYP			



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